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Ultrathin tin sulfide field-effect transistors with subthreshold slope below 60 mV/decade

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Abstract

In this paper, we present for the first time a field-effect-transistor (FET) having a 10 nm thick tin sulfide (SnS) channel fabricated at the wafer scale with high reproducibility. SnS-based FETs are in on-state for increasing positive back-gate voltages up to 6 V, whereas the off-state is attained for negative back-gate voltages not exceeding -6 V, the on/off ratio being in the range 10^2 - 10^3 depending on FET dimensions. The SnS FETs show a subthreshold slope (SS) below 60 mV/decade thanks to the in-plane ferroelectricity of SnS and attaining a minimum value $SS = 21$ mV/decade. Moreover, the low SS values can be explained by the existence of a negative value of the capacitance of the SnS thin film up to 10 GHz (for any DC bias voltage between 1 and 5 V), with the minimum value being -12.87 pF at 0.1 GHz.

Keywords: 2D materials ferroelectricity, ferroelectrics, microwaves, RF magnetron sputtering, semiconductors, thin films, tin sulfide

(Some figures may appear in colour only in the online journal)



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